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The RF Line

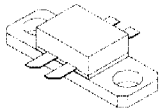
NPN Silicon RF Power Transistor

MRF897R

Designed for 24 Volt UHF large–signal, common emitter, class–AB linear amplifier applications in industrial and commercial FM/AM equipment operating in the range 800–970 MHz.

- Specified 24 Volt, 900 MHz Characteristics
  - Output Power = 30 Watts
  - Minimum Gain = 10.5 dB @ 900 MHz, class–AB
  - Minimum Efficiency = 30% @ 900 MHz, 30 Watts (PEP)
  - Maximum Intermodulation Distortion –30 dBc @ 30 Watts (PEP)
- Characterized with Series Equivalent Large–Signal Parameters from 800 to 960 MHz
- Silicon Nitride Passivated
- 100% Tested for Load Mismatch Stress at all Phase Angles with 5:1 VSWR @ 26 Vdc, and Rated Output Power
- Gold Metalized, Emitter Ballasted for Long Life and Resistance to Metal–Migration

30 W, 900 MHz
RF POWER
TRANSISTOR
NPN SILICON



CASE 395E–01

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector–Emitter Voltage	V_{CEO}	30	Vdc
Collector–Emitter Voltage	V_{CES}	60	Vdc
Emitter–Base Voltage	V_{EBO}	4.0	Vdc
Collector–Current — Continuous	I_C	4.0	Adc
Total Device Dissipation @ T_C = 25°C Derate above 25°C	P_D	105 0.60	Watts W/°C
Storage Temperature Range	T_{stg}	–65 to +150	°C

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Case	$R_{\theta JC}$	1.67	°C/W

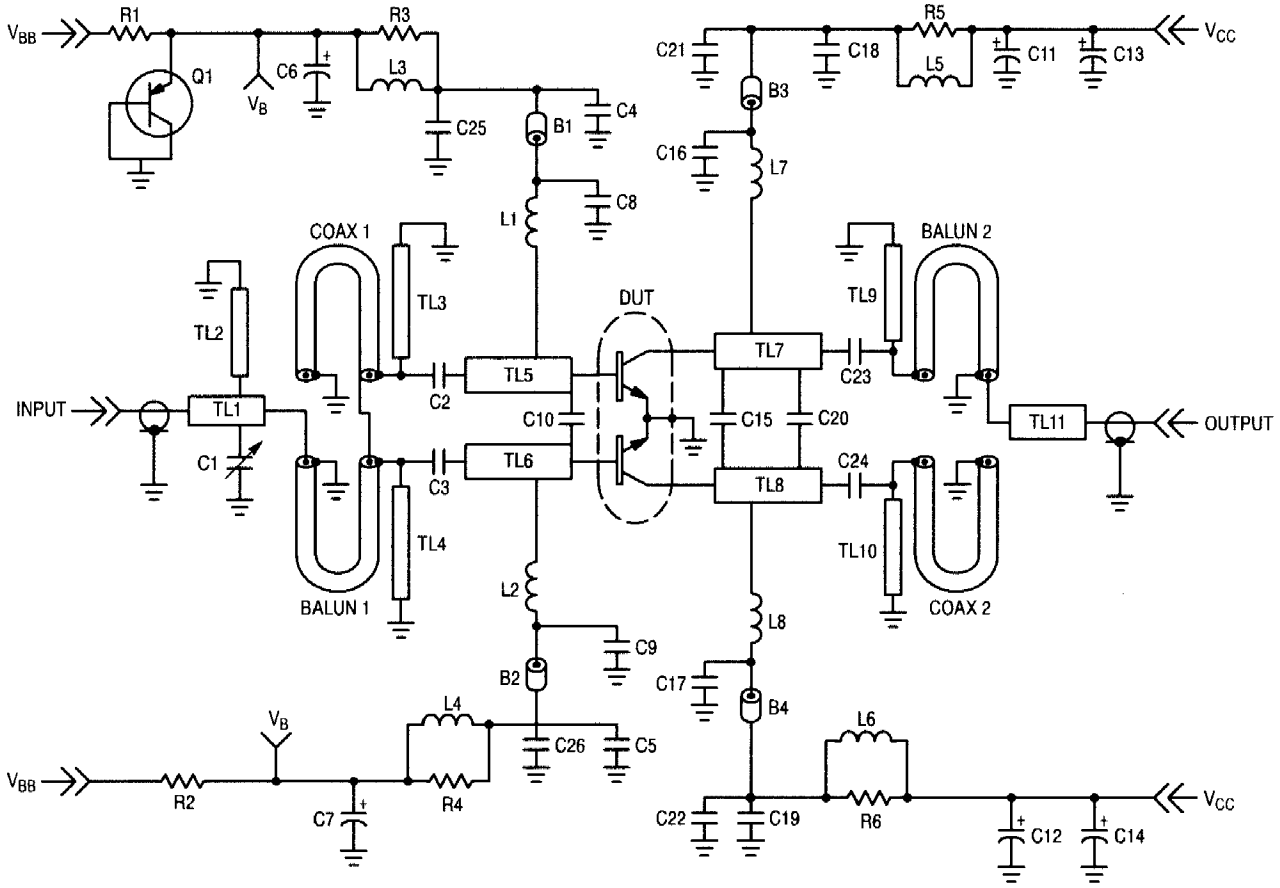
ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted)

Characteristic	Symbol	Min	Typ	Max	Unit
OFF CHARACTERISTICS					
Collector–Emitter Breakdown Voltage (I_C = 50 mAdc, I_B = 0)	$V_{(BR)CEO}$	30	33	—	Vdc
Collector–Emitter Breakdown Voltage (I_C = 50 mAdc, V_{BE} = 0)	$V_{(BR)CES}$	60	80	—	Vdc
Emitter–Base Breakdown Voltage (I_E = 5 mAdc, I_C = 0)	$V_{(BR)EBO}$	4.0	4.7	—	Vdc
Collector Cutoff Current (V_{CE} = 30 Vdc, V_{BE} = 0, T_C = 25°C)	I_{CES}	—	—	10.0	mAdc
ON CHARACTERISTICS					
DC Current Gain (I_{CE} = 1.0 Adc, V_{CE} = 5 Vdc)	h_{FE}	30	80	120	—
DYNAMIC CHARACTERISTICS					
Output Capacitance (V_{CB} = 24 Vdc, I_E = 0, f = 1.0 MHz)	C_{ob}	14	21	28	pF

(continued)

ELECTRICAL CHARACTERISTICS — continued (T_C = 25°C unless otherwise noted)

Characteristic	Symbol	Min	Typ	Max	Unit
FUNCTIONAL CHARACTERISTICS					
Common–Emitter Amplifier Power Gain (V_{CC} = 24 Vdc, P_{out} = 30 Watts (PEP), I_{cq} = 125 mA, f_1 = 900 MHz, f_2 = 900.1 MHz)	G_{pe}	10.5	12.0	—	dB
Collector Efficiency (V_{CC} = 24 Vdc, P_{out} = 30 Watts (PEP), I_{cq} = 125 mA, f_1 = 900 MHz, f_2 = 900.1 MHz)	η	30	38	—	%
Intermodulation Distortion (V_{CC} = 24 Vdc, P_{out} = 30 Watts (PEP), I_{cq} = 125 mA, f_1 = 900 MHz, f_2 = 900.1 MHz)	IMD	—	–37	–30	dBc
Output Mismatch Stress (V_{CC} = 26 Vdc, P_{out} = 30 Watts (PEP), I_{cq} = 125 mA, f_1 = 900 MHz, f_2 = 900.1 MHz, Load VSWR = 5:1 (all phase angles))	ψ	No Degradation in Output Power			



B1, B2, B3, B4 — Short Ferrite Bead, Fair Rite #2743019447
C1 — 0.8–8.0 pF Var Capacitor, Johansen Gigatrim
C2, C3, C23, C24 — 43 pF, 100 mil, ATC Chip Capacitor
C4, C5, C21, C22 — 1000 pF, 100 mil, ATC Chip Capacitor
C6, C7, C11, C12 — 10 µF, Electrolytic Capacitor, Panasonic
C8, C9, C16, C17 — 100 pF, 100 mil, ATC Chip Capacitor
C10 — 9.1 pF, 50 mil, ATC Chip Capacitor
C13 — 250 µF Electrolytic Capacitor, Mallory
C14, C18, C19, C25 — 0.1 µF, Chip Capacitor, Kemet
C15 — 1.1 pF, 50 mil, ATC Chip Capacitor
C20 — 6.8 pF, 100 mil, ATC Chip Capacitor
L1, L2, L3, L4, L5, L6, L7, L8 — 5 Turns 20 AWG, IDIA 0.126″ Choke, Taylor Spring 46 nH
N1, N2 — Type N Flange Mount, Omni Spectra 3052–1648–10
Q1 — Bias Transistor BD136 PNP
R1, R12 — 27 Ohm, 2.0 W
R3, R4, R5, R6 — 4.0 x 39 Ohm, 1/8 W, Chips Resistors in Parallel, Rohm 390–J
SB1 — 0.15″ x 0.3″ x 0.03″ Cu
TL1–TL11 — Microstrip Line, See Photomaster
Balun1, Balun2, Coax 1, Coax 2 — 2.20″ 50 Ohm, 0.086″ o.d. semi–rigid coax, Micro Coax UT–85–M17
Circuit Board — 1/32″ Glass Teflon, Arlon GX–0300–55–22, ε_r = 2.55

Figure 1. 840–900 MHz Test Circuit Schematic